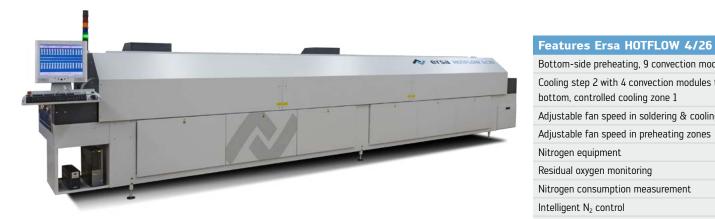


## High-end reflow soldering system with outstanding thermal performance and best energy balance



## Highest throughput, optimized $N_2$ and energy balance, best process control and maximum machine uptimes.

The new HOTFLOW 4 series of systems has been augmented by the Ersa HOTFLOW 4/26. This system, with a process length of more than 7 meters split into 26 heating zones and 4 cooling zones and characterized by its high energy efficiency, provides a vastly increased throughput while maintaining the customary high process- and soldering quality.

The reduction of operating cost is based on the use of economical and efficient fan motors, which reduce the consumption of power, and on the

**Unique Technology Advantages:** 

Optimized heat transfer, minimized Delta T,

■ Switchable internal/external cooling unit ■ 100% tested process tunnel (gas sealed)

Heating modules retractable without any tools

■ Lowest energy and N₂ consumption New process control software

Energy efficient blower motors

Ultra Low-Mass Center Support

zone separation & temperature controlled cooling

Dual and triple track transport

increases throughput

Best machine uptime

GRIP transport

energy saving is in the range of 25%.

From a productivity versus floor space requirement standpoint, the HOTFLOW sets the industry standard. With dual or triple track options, it is possible to increase throughput considerably without increasing floor space! Tracks run at their own set speed and at their own PCB width for maximum flexibility.

products simultaneously at three different set speeds and widths. Only highest quality materials have been used in order to quarantee the highest machine availability. Finally, all major parts are exchangeable within only minutes in order to keep machine downtime to an absolute minimum.

## Software-Highlights

- New process control software (EPC)
- ERSASOFT process data recorder
- ERSASOFT user friendly machine control
- AUTOPROFILER for rapid offline profiling
- Standby & sleep mode
- Job management

superior control of the N2 system, which reduces the consumption of  $N_2$  by 20%. All in all, total

It is now possible to run as many as three different

reatures Ersa HulfLuw 4/20	
Bottom-side preheating, 9 convection modules	
Cooling step 2 with 4 convection modules top and bottom, controlled cooling zone 1	
Adjustable fan speed in soldering & cooling zones	
Adjustable fan speed in preheating zones	
Nitrogen equipment	
Residual oxygen monitoring	
Nitrogen consumption measurement	
Intelligent N <sub>2</sub> control	
3 oxygen measuring points	
Residue Terminator	
Pyrometer	
Cooling aggregate	
Outfeed cooling	
Bottom-side motor cooling	
Temperature monitoring of the cooling zone	
Cooling step 1, basic cooling top and bottom	
External cold water supply	
GRIP transport	
Low-mass conveyor, 560 mm	
Low-mass track conveyor 1 to 3	
Adjustable speed for each track conveyor	
Low-mass support tubes, 540 mm/21" width	
Low-mass center support 1 to 3 with uninterrupted rest	
Program controlled width adjustment for conveyors and center support	
Automatic chain lubrication	
PC with TFT screen	
TFT touch screen	
Status indication light	
Emergency power supply (transport, hood, SPS, PC)	
Online servicing	
Temperature measurement device (SENSOR SHUTTLE)	
Ersa process control (EPC)	
AUTOPROFILER	
Energy measurement	
Energy consumption calculation	
Quick profile change	

standard **■** / option □



Grip conveyor for extremely thin PCB or flexfoils



Multi track conveyor for variable PCB width



Efficient cooling in outfeed section



Retractable nozzle sheets for auick maintenance



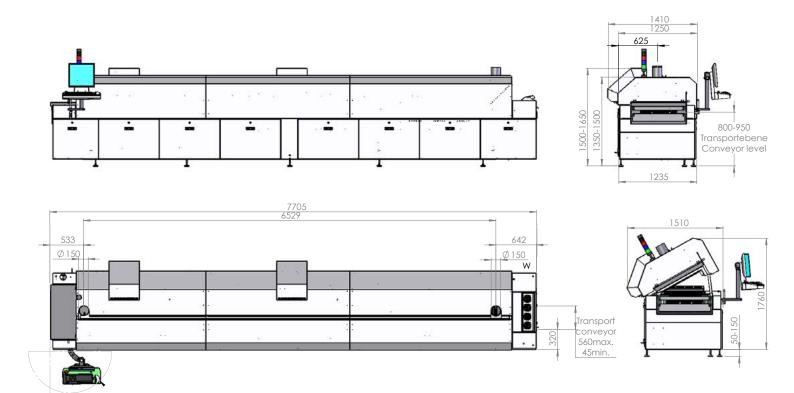
Optimized access to maintenance units



Ersa AUTOPROFILER: Easy offline profiling for highest machine uptimes.



## High-end reflow soldering system with outstanding thermal performance and best energy balance



Dimensions (Basic machine):	
Length:	7,705 mm
Width:	1,410 mm
Height:	1,350 – 1,500 mm
Height (open):	1,670 – 1,820 mm
Weight:	approx. 2,800 kg
Paint:	RAL 7035/7016

Conveyor system:	
Working width:	45 – 560 mm
Working width (PCB center sup	port): 45 – 560 mm
Board clearance (standard):	+32/-40 mm
Center support pin height:	19 mm
Conveyor speed:	20 – 200 cm/min
Conveyor height from floor:	820 – 980 mm
Pin-and-chain conveyor:	3 mm edge clearance

Process zone:	
Process length:	7,115 mm
Heating zone:	5,000 mm
Cooling zone:	2,115 mm
Infeed zone:	620 mm
Process chamber width:	approx. 745 mm

Heating system:	
Convection share:	100 %
Gas flow/module:	approx. 500 m $^3$ /h (17,657 ft $^3$ /h), adjustable
Convection modules::	13 top/13 bottom
Preheating::	9 top/9 bottom
Soldering zone:	4 top/4 bottom
Nominal rating per mo	odule: 3,3 kW

Cooling:	
Cooling zone:	4-stage version and water recooling
Coolant:	water/R134A (option)/air
Ambient tempera	ature: max. 32°C (90°F)

Nitrogen option:	
Gas injection:	in process zones
Pressure control:	4,5 – 10 bar

Safety devices:
1 x Main switch
2 x Emergency-Stop buttons
2 x Exhaust monitors

Electrical data:	
Power:	5-wire-system, 3 x 400 V, N, PE
Power tolerance range:	±10 %
Frequency:	50/60 Hz
Max. fuse rating:	3 x 100 A
Nominal rating: (subject to configuration	83 kW – 102 kW
Reduced rating:	55 kW
Continuous rating for op	eration ca. 12 – 19 KW

Exhaust rating:		
Exhaust stacks:	2 stacks, 150	mm (6") ø each
Exhaust volume per stack:		600 m <sup>3</sup> /h
Exhaust monitoring per stack:		integrated

Noise level:	
Permanent noise level:	< 65 dB (A)

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